## **Si2319DDS**

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**Vishay Siliconix** 

**RoHS** 

COMPLIANT

HALOGEN

FREE





#### Marking code: G4

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-40				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.075				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.100				
Q <sub>g</sub> typ. (nC)	6				
I <sub>D</sub> (A)	-3.6 <sup>a</sup>				
Configuration	Single				

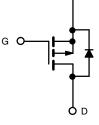
#### **FEATURES**

P-Channel 40 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Gen III p-channel power MOSFET
- 100 %  $\rm R_g$  and UIS tested
- Material categorization:
- for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Battery switch
- Motor drive control
- · Load switch



o s

P-Channel MOSFET

ORDERING INFORMATION				
Package	SOT-23			
Lead (Pb)-free and halogen-free	Si2319DDS-T1-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-40	V
Gate-source voltage		V <sub>GS</sub>	± 20	v
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-3.6	
	T <sub>C</sub> = 70 °C	1 .	-2.9	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-2.7 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1	-2.2 <sup>b, c</sup>	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-15	— A
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	-1.4	
	T <sub>A</sub> = 25 °C		-0.8 <sup>b, c</sup>	
Single pulse avalanche current		I <sub>AS</sub>	-5	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	1.25	mJ
	T <sub>C</sub> = 25 °C		1.7	
Maximum power dissipation	T <sub>C</sub> = 70 °C	1. [	1.1	14/
	T <sub>A</sub> = 25 °C	- I <sub>P</sub>	1 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C	1	0.6 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	t ≤ 5 s	R <sub>thJA</sub>	100	130	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJF</sub>	60 75 6/		0/10	

Notes

a. Based on  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 175 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-40	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -250 μA	-	-27.5	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	3.2	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	-1	-	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA	
Zene ante colte de alusia acoment		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	— uA	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = -40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	-15		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ -10 V, $V_{GS}$ = -10 V	-10	-	-	Α	
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -2.7 A	-	0.062	0.075		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -2.4 A	-	0.081	0.100	Ω	
Forward transconductance a	g <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -2.7 A	-	10	-	S	
Dynamic <sup>b</sup>				•	•		
Input capacitance	C <sub>iss</sub>		-	650	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	54	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	43	-		
Total gate charge	Qg	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.7 \text{ A}$	-	12.5	19		
			-	6	12		
Gate-source charge	Q <sub>gs</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> =-2.7 A	-	1.8	-	nC	
Gate-drain charge	Q <sub>qd</sub>		-	2	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	2	10	20	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	V <sub>DD</sub> = -20 V, R <sub>L</sub> = 9.1 Ω, I <sub>D</sub> ≅ -2.2 A,	-	20	30	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	20	30	-	
Fall time	t <sub>f</sub>		-	12	24		
Turn-on delay time	t <sub>d(on)</sub>		-	30	45	ns	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = -20 V, R <sub>L</sub> = 9.1 Ω, I <sub>D</sub> ≅ -2.2 A,	-	32	48	-	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	20	30		
Fall time	t <sub>f</sub>		-	15	30		
Drain-Source Body Diode Characterist	ics			•	•		
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-1.4	•	
Pulse diode forward current	I <sub>SM</sub>		-	-	-15	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -2.2 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	15	30	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	9	18	nC	
Reverse recovery fall time	ta	I <sub>F</sub> = -2.2 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	10.5	-		
Reverse recovery rise time	t <sub>b</sub>	1	-	4.5	-	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

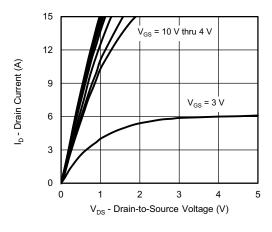
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

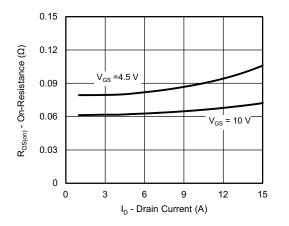
2



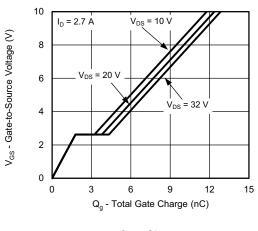
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



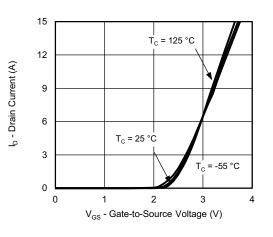
**Output Characteristics** 



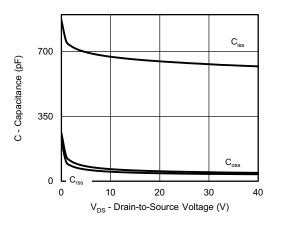
**On-Resistance vs. Drain Current and Gate Voltage** 



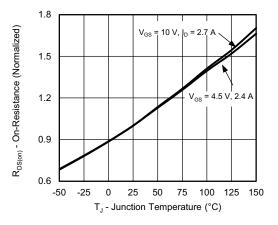
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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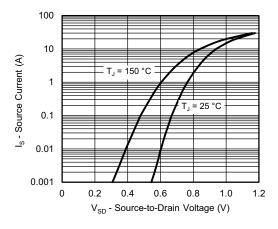
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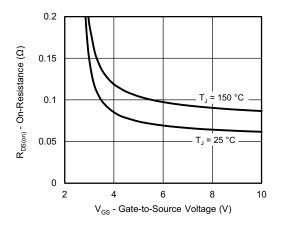
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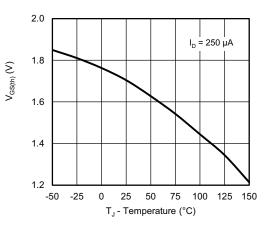
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



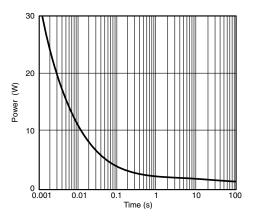
Source-Drain Diode Forward Voltage



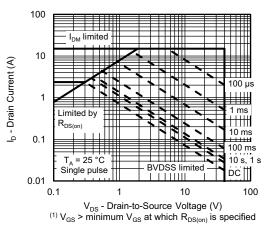
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

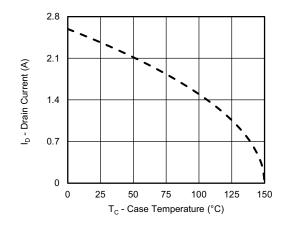
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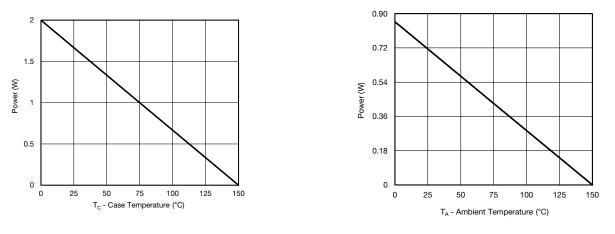
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating <sup>a</sup>



Power, Junction-to-Case

Power, Junction-to-Ambient

#### Note

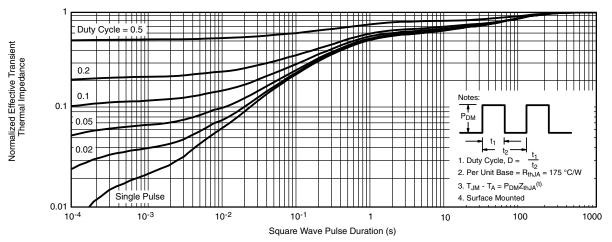
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



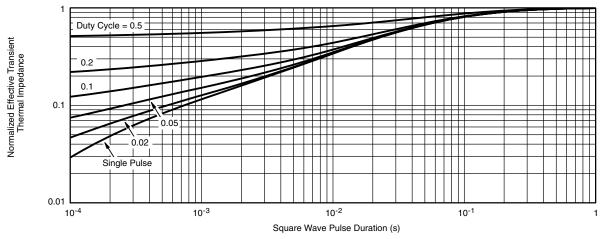
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?79400.

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# Package Information

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## SOT-23 (TO-236): 3-LEAD



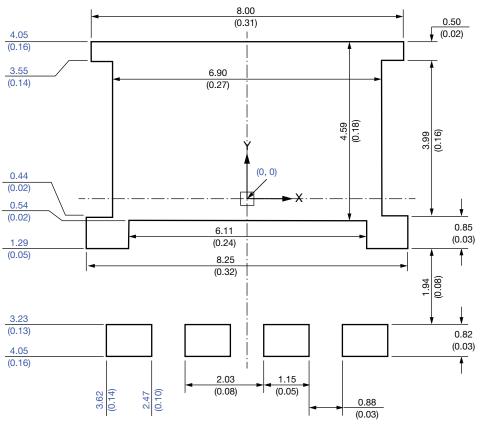




Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



# **Recommended Minimum PADs for PowerPAK® 8 x 8L Single**



Dimensions in millimeters (inches)

#### Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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